

ABSTRACT

A multi stage mounting printed circuit board system and method is presented.

In one embodiment, a multi stage mounting printed circuit board system includes a
5 first printed circuit board for mounting electrical components on. A first printed
circuit board interface component is coupled to the first printed circuit board. The first
printed circuit board interface component communicatively couples the first printed
board to a second printed board via a second printed circuit board interface
component. A plurality of printed circuit board extractors are coupled to the first
10 printed circuit board. The plurality of printed circuit board extractors couple the first
printed circuit board to card guides (e.g., a single pair of card guides in which the
second printed circuit board is mounted).